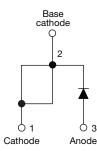


Vishay Semiconductors

HEXFRED[®], Ultrafast Soft Recovery Diode, 6 A



TO-247AC modified



| PRODUCT SUMMARY | | | | | | |
|----------------------------------|------------|--|--|--|--|--|
| Package TO-247AC modified (2) | | | | | | |
| I _{F(AV)} | 6 A | | | | | |
| V _R | 1200 V | | | | | |
| V _F at I _F | 2.4 V | | | | | |
| t _{rr} typ. | 26 ns | | | | | |
| T _J max. | 150 °C | | | | | |
| Diode variation | Single die | | | | | |

FEATURES

- Ultrafast and ultrasoft recovery
- Very low I_{RRM} and Q_{rr}
- Designed and qualified according to JEDEC®-JESD47
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

BENEFITS

- Reduced RFI and EMI
- · Reduced power loss in diode and switching transistor
- Higher frequency operation
- Reduced snubbing
- Reduced parts count

DESCRIPTION

VS-HFA06PB120... is a state of the art ultrafast recovery diode. Employing the latest in epitaxial construction and advanced processing techniques it features a superb combination of characteristics which result in performance which is unsurpassed by any rectifier previously available. With basic ratings of 1200 V and 6 A continuous current, the VS-HFA06PB120... is especially well suited for use as the companion diode for IGBTs and MOSFETs. In addition to ultrafast recovery time, the HEXFRED® product line features extremely low values of peak recovery current (I_{RBM}) and does not exhibit any tendency to "snap-off" during the t_b portion of recovery. The HEXFRED features combine to offer designers a rectifier with lower noise and significantly lower switching losses in both the diode and the switching transistor. These HEXFRED advantages can help to significantly reduce snubbing, component count and heatsink sizes. The HEXFRED VS-HFA06PB120 ... is ideally suited for applications in power supplies and power conversion systems (such as inverters), motor drives, and many other similar applications where high speed, high efficiency is needed.

| ABSOLUTE MAXIMUM RATINGS | | | | | | |
|--|-----------------------------------|-------------------------|-------------|-------|--|--|
| PARAMETER | SYMBOL | TEST CONDITIONS | VALUES | UNITS | | |
| Cathode to anode voltage | V _R | | 1200 | V | | |
| Maximum continuous forward current | I _F | T _C = 100 °C | 6 | | | |
| Single pulse forward current | I _{FSM} | | 80 | А | | |
| Maximum repetitive forward current | I _{FRM} | | 24 | | | |
| Maximum namer dissinction | P _D | T _C = 25 °C | 62.5 | W | | |
| Maximum power dissipation | | T _C = 100 °C | 25 | vv | | |
| Operating junction and storage temperature range | T _J , T _{Stg} | | -55 to +150 | °C | | |

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RoHS

COMPLIANT

HALOGEN

FREE



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| ELECTRICAL SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$ unless otherwise specified) | | | | | | | |
|---|-----------------|---|------|-------|-----|----|--|
| PARAMETER | SYMBOL | TEST CONDITIONS | MAX. | UNITS | | | |
| Cathode to anode breakdown voltage | V _{BR} | I _R = 100 μA | 1200 | - | - | | |
| Maximum forward voltage | | I _F = 6.0 A | - | 2.7 | 3.0 | v | |
| | V_{FM} | I _F = 12 A | - | 3.5 | 3.9 | | |
| | | I _F = 6.0 A, T _J = 125 °C | - | 2.4 | 2.8 | | |
| Maximum reverse | | $V_R = V_R$ rated | - | 0.26 | 5.0 | | |
| leakage current | IRM | T_J = 125 °C, V_R = 0.8 x V_R rated | - | 110 | 500 | μA | |
| Junction capacitance | CT | V _R = 200 V | - | 9.0 | 14 | pF | |
| Series inductance | L _S | Measured lead to lead 5 mm from package body | - | 8.0 | - | nH | |

| DYNAMIC RECOVERY CHARACTERISTICS ($T_c = 25$ °C unless otherwise specified) | | | | | | | |
|---|---------------------------|---|--|------|------|------|-------|
| PARAMETER | SYMBOL | TEST CO | NDITIONS | MIN. | TYP. | MAX. | UNITS |
| | t _{rr} | I _F = 1.0 A, dI _F /dt = 200 | A/ μ s, V _R = 30 V | - | 26 | - | |
| Reverse recovery time | t _{rr1} | T _J = 25 °C | | - | 53 | 80 | ns |
| | t _{rr2} | T _J = 125 °C | I _F = 6.0 A dI _F /dt = 200 A/μs V _R = 200 V | - | 87 | 130 | |
| Peak recovery current | I _{RRM1} | T _J = 25 °C | | - | 4.4 | 8.0 | A |
| | I _{RRM2} | T _J = 125 °C | | - | 5.0 | 9.0 | |
| | Q _{rr1} | T _J = 25 °C | | - | 116 | 320 | nC |
| Reverse recovery charge | Q _{rr2} | T _J = 125 °C | | - | 233 | 585 | ne |
| Peak rate of recovery current during $t_{\rm b}$ | dl _{(rec)M} /dt1 | T _J = 25 °C | | - | 180 | - | Δ/μο |
| | dl _{(rec)M} /dt2 | T _J = 125 °C | | - | 100 | - | A∕µs |

| THERMAL - MECHANICAL SPECIFICATIONS | | | | | | | |
|--|-------------------|--|--------------|------|------------|------------------------|--|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS | |
| Lead temperature | T _{lead} | 0.063" from case (1.6 mm) for 10 s | - | - | 300 | °C | |
| Thermal resistance, junction to case | R _{thJC} | | - | - | 2.0 | | |
| Thermal resistance, junction to ambient | R _{thJA} | Typical socket mount | | - | 80 | K/W | |
| Thermal resistance, case to heatsink | R _{thCS} | Mounting surface, flat, smooth and greased | - | 0.5 | - | | |
| Weight | | | - | 2.0 | - | g | |
| weight | | | - | 0.07 | - | oz. | |
| Mounting torque | | | 6.0 (5.0) | - | 12 (10) | kgf · cm (lbf · in) | |
| Marking device | | Case style TO-247AC modified | HFA06PB120 | | | | |

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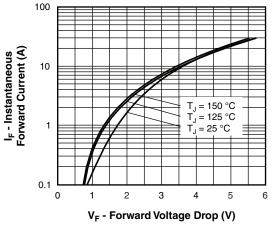
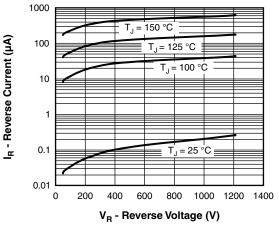
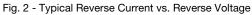


Fig. 1 - Typical Forward Voltage Drop Characteristics





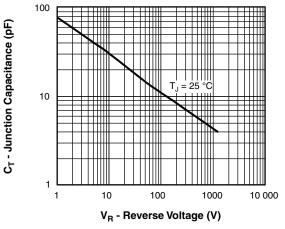


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

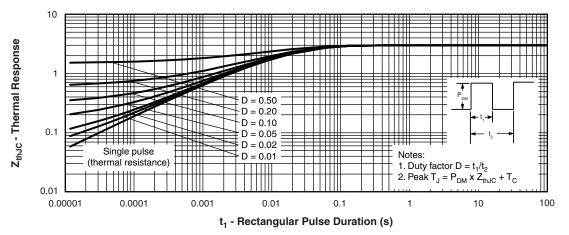


Fig. 4 - Maximum Thermal Impedance ZthJC Characteristics

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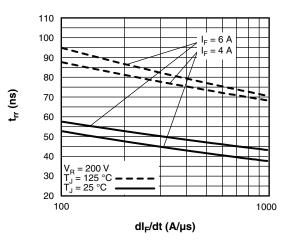


Fig. 5 - Typical Reverse Recovery Time vs. dI_F/dt

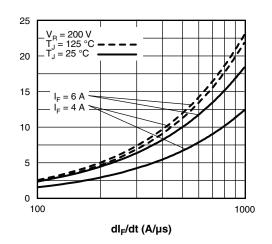


Fig. 6 - Typical Recovery Current vs. dl_F/dt

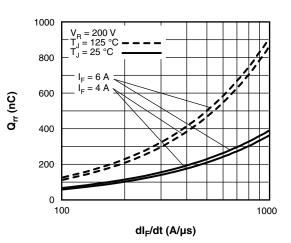
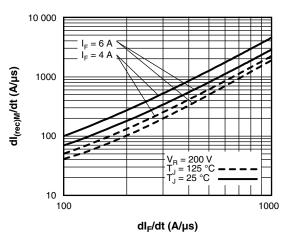


Fig. 7 - Typical Stored Charge vs. dl_F/dt





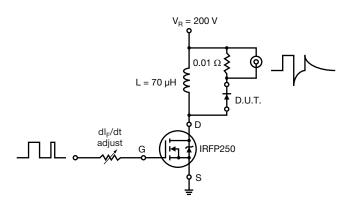


Fig. 9 - Reverse Recovery Parameter Test Circuit

I_{rr} (A)



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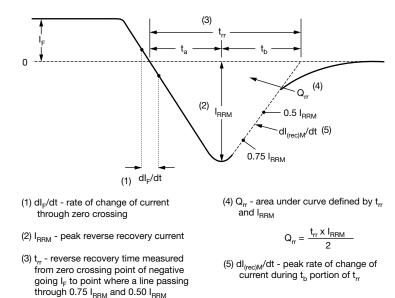
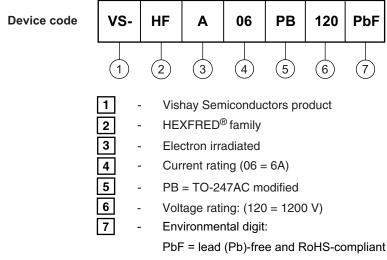


Fig. 10 - Reverse Recovery Waveform and Definitions

ORDERING INFORMATION TABLE



extrapolated to zero current.

-N3 = halogen-free, RoHS-compliant, and totally lead (Pb)-free

| ORDERING INFORMATION (Example) | | | | | | | |
|--------------------------------|------------------|------------------------|-------------------------|--|--|--|--|
| PREFERRED P/N | QUANTITY PER T/R | MINIMUM ORDER QUANTITY | PACKAGING DESCRIPTION | | | | |
| VS-HFA06PB120PbF | 25 | 500 | Antistatic plastic tube | | | | |
| VS-HFA06PB120-N3 | 25 | 500 | Antistatic plastic tube | | | | |

| LINKS TO RELATED DOCUMENTS | | | | | | |
|----------------------------|-----------------------|--------------------------|--|--|--|--|
| Dimensions | | www.vishay.com/doc?95541 | | | | |
| | TO-247AC modified PbF | www.vishay.com/doc?95255 | | | | |
| Part marking information | TO-247AC modified -N3 | www.vishay.com/doc?95442 | | | | |

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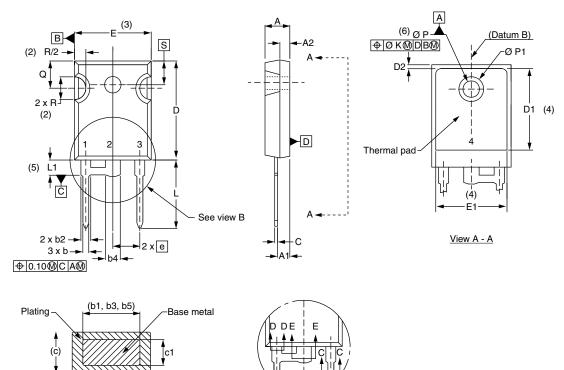
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Vishay Semiconductors

TO-247AC modified

DIMENSIONS in millimeters and inches



Section C - C, D - D, E - E

(4)

(b. b2. b4)

| View | B |
|------|---|

| SYMBOL | MILLIN | IETERS | INCHES | | NOTES |
|----------|--------|--------|--------|-------|-------|
| STIVIBOL | MIN. | MAX. | MIN. | MAX. | NOTES |
| А | 4.65 | 5.31 | 0.183 | 0.209 | |
| A1 | 2.21 | 2.59 | 0.087 | 0.102 | |
| A2 | 1.50 | 2.49 | 0.059 | 0.098 | |
| b | 0.99 | 1.40 | 0.039 | 0.055 | |
| b1 | 0.99 | 1.35 | 0.039 | 0.053 | |
| b2 | 1.65 | 2.39 | 0.065 | 0.094 | |
| b3 | 1.65 | 2.34 | 0.065 | 0.092 | |
| b4 | 2.59 | 3.43 | 0.102 | 0.135 | |
| b5 | 2.59 | 3.38 | 0.102 | 0.133 | |
| с | 0.38 | 0.89 | 0.015 | 0.035 | |
| c1 | 0.38 | 0.84 | 0.015 | 0.033 | |
| D | 19.71 | 20.70 | 0.776 | 0.815 | 3 |
| D1 | 13.08 | - | 0.515 | - | 4 |

| SYMBOL | MILLIMETERS | | INCHES | | NOTES |
|--------|-------------|-------|-----------|-------|-------|
| STWDUL | MIN. | MAX. | MIN. | MAX. | NOTES |
| D2 | 0.51 | 1.30 | 0.020 | 0.051 | |
| E | 15.29 | 15.87 | 0.602 | 0.625 | 3 |
| E1 | 13.72 | - | 0.540 | - | |
| е | 5.46 BSC | | 0.215 | BSC | |
| ØК | 2.54 | | 0.010 | | |
| L | 14.20 | 16.10 | 0.559 | 0.634 | |
| L1 | 3.71 | 4.29 | 0.146 | 0.169 | |
| ØΡ | 3.56 | 3.66 | 0.14 | 0.144 | |
| Ø P1 | - | 6.98 | - | 0.275 | |
| Q | 5.31 | 5.69 | 0.209 | 0.224 | |
| R | 4.52 | 5.49 | 0.178 | 0.216 | |
| S | 5.51 | BSC | 0.217 BSC | | |
| | | | | | |

Notes

- ⁽¹⁾ Dimensioning and tolerance per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- ⁽⁴⁾ Thermal pad contour optional with dimensions D1 and E1
- ⁽⁵⁾ Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension c

Revision: 20-Apr-17

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